



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| BVDSS | Rds(on) Max | I _D Max T _A = +25°C |
|-------|-------------------------------|--|
| | 40mΩ @ VGS = 10V | 5.5A |
| 60V | 55mΩ @ V _{GS} = 4.5V | 4.7A |

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Backlighting
- Power management functions
- DC-DC converters

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DIODES DMN6040SSSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

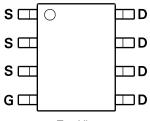
https://www.diodes.com/quality/product-definitions/

Mechanical Data

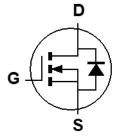
- Package: SO-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (63)
- Weight: 0.076 grams (Approximate)



Top View



Top View Pin Configuration



Equivalent Circuit

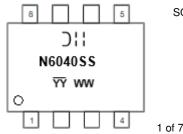
Ordering Information (Note 4)

| Part Number | Dockers | Packing | | |
|----------------|---------|---------|-------------|--|
| Part Number | Package | Qty. | Carrier | |
| DMN6040SSSQ-13 | SO-8 | 2500 | Tape & Reel | |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



SO-8

⊃¦¦ = Manufacturer's Marking
 N6040SS = Product Type Marking Code

 \overline{YY}WW = Date Code Marking

 \overline{YY} = Year (ex: 23 = 2023)

 WW = Week (01 to 53)



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

| Characteristic | | | Symbol | Value | Units |
|--|--|--|------------------|------------|-------|
| Drain-Source Voltage | | | VDSS | 60 | V |
| Gate-Source Voltage | | | V _{GSS} | ±20 | V |
| Continuous Drain Current (Note 5) $V_{GS} = 10V$ Steady $T_{A} = +25^{\circ}C$ State $T_{A} = +70^{\circ}C$ | | | lo | 5.5 4.4 | Α |
| Maximum Continuous Body Diode Forward Current (Note 5) | | | Is | 2.5 | Α |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | | I _{DM} | 30 | Α |
| Avalanche Current , L = 0.1mH | | | lar | 14.2 | Α |
| Repetitive Avalanche Energy, L = 0.1mH | | | Ear | 10 | mJ |

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Units | | |
|--|--------------|-----------------|-------------|------|--|
| Total Power Dissipation (Note 6) | | P _D | 1.5 | W | |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | Reja | 80 | °C/W | |
| Total Power Dissipation (Note 5) | PD | 2.0 | W | | |
| Thermal Resistance, Junction to Ambient (Note 5) Steady State | | $R_{\theta JA}$ | 61 | °C/W | |
| Thermal Resistance, Junction to Case | | Rejc | 6.4 | C/VV | |
| Operating and Storage Temperature Range | | TJ, TSTG | -55 to +150 | °C | |

Electrical Characteristics (T_A = +25°C, unless otherwise specified.)

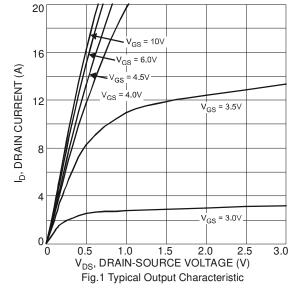
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|---------------------|-----|------|------|------|--|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 60 | _ | _ | V | $V_{GS} = 0V, I_D = 250\mu A$ | |
| Zero Gate Voltage Drain Current | IDSS | _ | _ | 1 | μΑ | $V_{DS} = 60V$, $V_{GS} = 0V$ | |
| Gate-Source Leakage | Igss | _ | | ±100 | nA | $V_{GS} = \pm 20V$, $V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | 1 | _ | 3 | V | V _{DS} = V _{GS} , I _D = 250μA | |
| Static Drain-Source On-Resistance | D | _ | 30 | 40 | m0 | V _G S = 10V, I _D = 4.5A | |
| Static Drain-Source On-Resistance | RDS(ON) | _ | 35 | 55 | mΩ | $V_{GS} = 4.5V, I_D = 3.5A$ | |
| Diode Forward Voltage | V _{SD} | _ | 0.7 | 1.2 | V | V _{GS} = 0V, I _S = 1A | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | |
| Input Capacitance | Ciss | _ | 1287 | _ | | V _{DS} = 25V, V _{GS} = 0V f = 1.0MHz | |
| Output Capacitance | Coss | _ | 57 | _ | рF | | |
| Reverse Transfer Capacitance | Crss | _ | 44 | _ | | | |
| Gate Resistance | Rg | _ | 1.2 | _ | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$ | |
| Total Gate Charge (VGS = 10V) | Qg | _ | 22.4 | _ | | | |
| Total Gate Charge (V _{GS} = 4.5V) | Q_g | _ | 10.4 | _ | nC | $V_{DS} = 30V, I_D = 4.3A$ | |
| Gate-Source Charge | Qgs | _ | 4.9 | _ | IIC | | |
| Gate-Drain Charge | Qgd | _ | 3.0 | _ | | | |
| Turn-On Delay Time | tD(on) | _ | 6.6 | _ | | | |
| Turn-On Rise Time | tr | _ | 8.1 | _ | ns | $V_{GS}=10V,\ V_{DD}=30V,\ R_G=6\Omega$ $I_D=4.3A$ | |
| Turn-Off Delay Time | tD(off) | _ | 20.1 | _ | 115 | | |
| Turn-Off Fall Time | tf | | 4.0 | | | | |
| Body Diode Reverse Recovery Time | t _{rr} | _ | 18 | _ | ns | I _S = 4.3A, dI/dt = 100A/µs | |
| Body Diode Reverse Recovery Charge | Qrr | _ | 11.9 | _ | nC | Is = 4.3A, dI/dt = 100A/µs | |

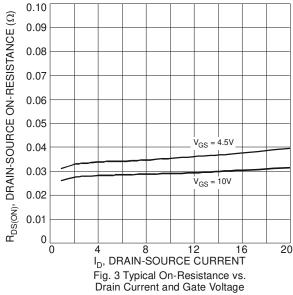
Notes:

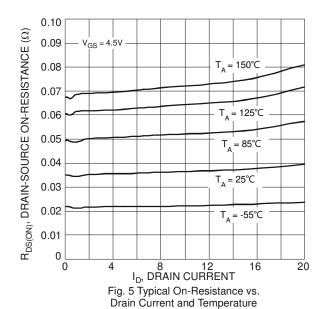
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.

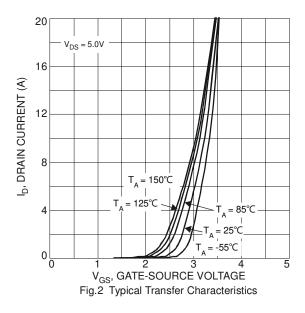


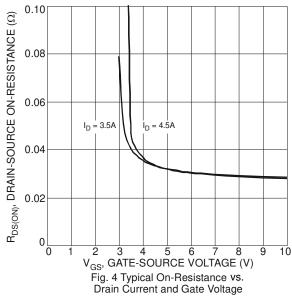












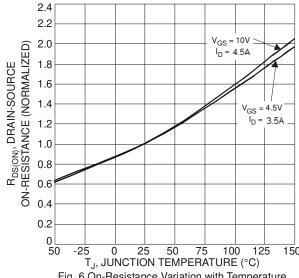
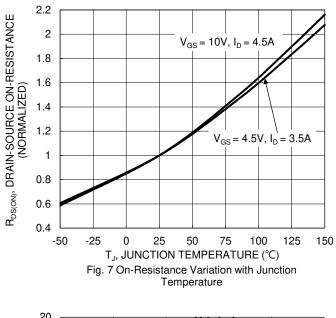
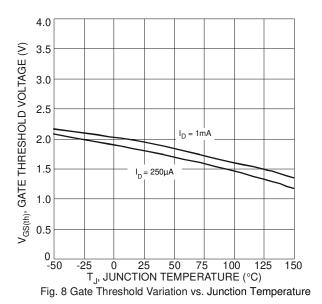


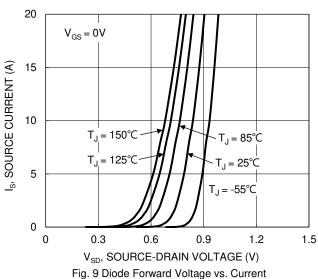
Fig. 6 On-Resistance Variation with Temperature

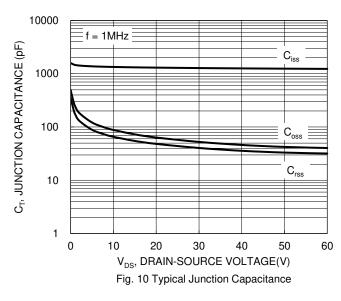


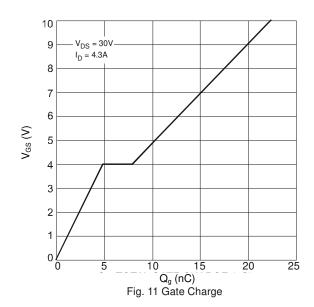


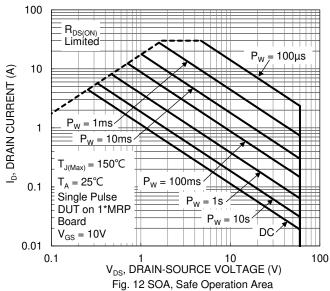














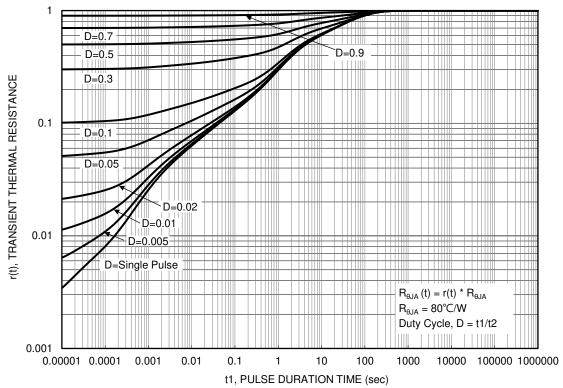


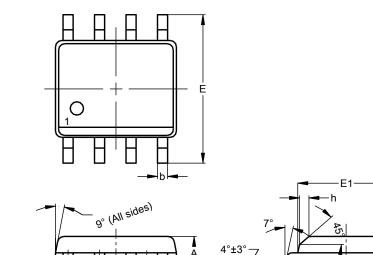
Fig. 13 Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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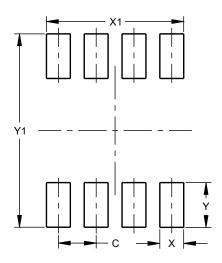
| SO-8 | | | | | |
|------|----------------------|------|------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 1.40 | 1.50 | 1.45 | | |
| A1 | 0.10 | 0.20 | 0.15 | | |
| b | 0.30 | 0.50 | 0.40 | | |
| С | 0.15 | 0.25 | 0.20 | | |
| D | 4.85 | 4.95 | 4.90 | | |
| Е | 5.90 | 6.10 | 6.00 | | |
| E1 | 3.80 | 3.90 | 3.85 | | |
| E0 | 3.85 | 3.95 | 3.90 | | |
| е | | | 1.27 | | |
| h | | | 0.35 | | |
| L | 0.62 | 0.82 | 0.72 | | |
| Q | 0.60 | 0.70 | 0.65 | | |
| All | All Dimensions in mm | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

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E0



| Dimensions | Value (in mm) | | | |
|------------|---------------|--|--|--|
| С | 1.27 | | | |
| Х | 0.802 | | | |
| X1 | 4.612 | | | |
| Υ | 1.505 | | | |
| Y1 | 6.50 | | | |

-Gauge Plane Seating Plane



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